•3.

L Number	Hits	Search Text	DB	Time stamp
53	49	flexible near pcb and heat near sink	USPAT;	2004/09/27
53	0	noxino nom pos ana nom nom onni	US-PGPUB;	15:29
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
54	3145	pcb and heat near sink	USPAT;	2004/09/27
34	3143	pes and neat near sink	US-PGPUB;	15:29
l			EPO; JPO;	10120
İ			DERWENT;	
			IBM_TDB	٠
55	20	net and best year sink and banding adi film	USPAT;	2004/09/27
55	20	pcb and heat near sink and bonding adj film	1	15:36
		,	US-PGPUB;	13:30
			EPO; JPO;	
			DERWENT;	
	_		IBM_TDB	
56	0	20030019568.URPN.	USPAT	2004/09/27
				15:31
57	5	("4691225"   "5473514"   "5583378"	USPAT	2004/09/27
		"5614443"   "5671531").PN.		15:34
58	0	20030019568.URPN.	USPAT	2004/09/27
				15:35
59	3145	pcb and heat near sink	USPAT;	2004/09/27
			US-PGPUB;	15:37
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
60	2549	pcb and printed adj circuit and heat near	USPAT;	2004/09/27
		sink	US-PGPUB;	15:37
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
61	2540	pcb and printed adj circuit and heat adj sink	USPAT;	2004/09/27
· .	2040	pos and printed day enount and neat day sink	US-PGPUB;	15:37
			EPO; JPO;	13.37
ļ			DERWENT;	
İ			IBM_TDB	
60	4004		_	2004/09/27
62	1091	pcb and printed adj circuit and heat adj sink	USPAT;	
		and bonding	US-PGPUB;	15:38
			EPO; JPO;	-
			DERWENT;	
			IBM_TDB	
63	91	pcb and printed adj circuit and heat adj sink	USPAT;	2004/09/27
ľ		and adhesive near bonding	US-PGPUB;	15:44
		·	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
64	1248	McCutcheon near Jeffrey W. inv.	USPAT;	2004/09/27
			US-PGPUB;	15:43
İ		·	EPO; JPO;	
		,	DERWENT;	
			IBM_TDB	

65	1	McCutcheon near Jeffrey. inv.	USPAT;	2004/09/27
			US-PGPUB;	15:43
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
66	20	flexible adj printed adj circuit and heat adj	USPAT;	2004/09/27
		sink and adhesive near bonding	US-PGPUB;	15:57
!			EPO; JPO;	
		_	DERWENT;	
			IBM_TDB	
67	3	flexible adj printed adj circuit and heat adj	USPAT;	2004/09/27
		sink and adhesive near bonding and	US-PGPUB;	16:01
		(174/88R; 174/94R ; 174/259 ; 174/257 ;	EPO; JPO;	
		174/258 ; 174/254	DERWENT;	
		; 174/255 ; 174/262 ; 174/264 ;	IBM_TDB	
		174/265 ; 174/266 ; 156/150	•	
		; 156/151 ; 156/252 ; 156/277 ;		
		156/299 ; 156/300 ; 156/306.9		
		; 156/307.7 ; 156/309.6 ; 361/749 ;		
		361/792 ; 29/830		
		; 427/97).ccls.		
		,		
68	16	("4783695"   "4820781"   "5106667"	USPAT	2004/09/27
		"5157589"   "5219640"   "5232548"		15:59
	!	"5237205"   "5298331"   "5359496"		
-		"5434751"   "5480841"   "5552222"		
	-	"5728473"   "5734008"   "5795162"		
		"5859181").PN.		
69	13	laminate adj heat near sink and circuit adj	USPAT;	2004/09/27
		board	US-PGPUB;	16:11
		·	EPO; JPO;	
			DERWENT;	
	1		IBM_TDB	
70	7	("5332695"   "5561321"   "5675474"	USPAT	2004/09/27
		"5786633"   "6046907"   "6081426"		16:08
		"6188579").PN.	·	
71	1	laminate adj heat near sink and flexible near	USPAT;	2004/09/27
		circuit and heating	US-PGPUB;	16:17
	1		EPO; JPO;	
			DERWENT;	
			IBM_TDB	
72	o	laminate adj heat near sink and pcb and	USPAT;	2004/09/27
		heating	US-PGPUB;	16:17
		_ ·	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
73	59	heat near sink and laminating and pcb and	USPAT;	2004/09/27
		heating	US-PGPUB;	16:29
		_	EPO; JPO;	
			DERWENT;	
			IBM_TDB	

74	19	("3244795"   "4087300"   "4388129"	USPAT	2004/09/27
		"4421827"   "4465538"   "4510008"		16:24
		"4642160"   "4803022"   "4927477"		
		"5296651"   "5360887"   "5362534"		
		"5382757"   "5455393"   "5478972"		
		"5481795"   "5496971"   "5544773"		
		"5550325").PN.		
75	8	heat near sink and laminating and pcb and	USPAT;	2004/09/27
		heating and 29/\$.ccls.	US-PGPUB;	16:34
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
76	18	("4012832"   "4075388"   "4242157"	USPAT	2004/09/27
		"4436242"   "4664739"   "4818823"		16:31
		"4936010"   "5072874"   "5137836"		
		"5146981"   "5182852"   "5253010"		
	!	"5268048"   "5451285"   "5471027"		
!		"5601675"   "5616958"   "5632438").PN.		
77	15	("3405323"   "4069498"   "4092697"	USPAT	2004/09/27
		"4193445"   "4254431"   "4462462"		16:32
		"4498119"   "4561011"   "4639829"		
		"4682269"   "4794981"   "4879632"		
		"4965699"   "4974119"   "5012858").PN.		
78	140	heat near sink and laminating and (29/830;	USPAT;	2004/09/27
		29/840 ; 29/841 ; 29/832 ; 438/15 ; 438/119 ;	US-PGPUB;	16:48
		438/4	EPO; JPO;	
		; 257/717 ; 257/700 ; 257/738 ;	DERWENT;	
		257/706 ; 257/701 ; 257/707	IBM_TDB	
		; 257/787 ; 257/796 ; 156/94 ;		
		156/297).ccis.		0004/00/07
79	8	("4770953"   "5011732"   "5130498"	USPAT	2004/09/27
		"5145540"   "5213877"   "5529852"		16:40
	7	"5616421"   "5675474").PN.	USPAT;	2004/09/27
80	_ [	Fraivillig near James .inv.	US-PGPUB:	16:48
		·	EPO; JPO;	10:40
		,	DERWENT;	
			IBM_TDB	